

SSC8036GQ4

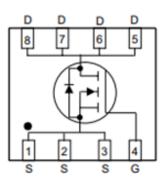
N-Channel Enhancement Mode MOSFET

> Features

VDS	VGS	RDSON Typ.	ID
30V	1201/	14mR@10V	104
	±20V	20mR@4V5	18A

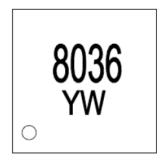
> Description

This device uses advanced trench technology to provide excellent RDSON and low gate charge. This device is suitable for use as a load switch or in PWM applications. > Pin configuration





Bottom View



(Y: year/W: week) Marking

> Applications

- Load Switch
- NB/PC
- DCDC conversion

> Ordering Information

Device	Package	Shipping
SSC8036GQ4	DFN3x3	5000/Reel



Symbol	Parameter	Ratings	Unit	
V _{DSS}	Drain-to-Source Voltage		30	V
V _{GSS}	Gate-to-Source Voltag	Gate-to-Source Voltage		V
	O antina and Drain O anna t	TC=25℃	18	А
ID	Continuous Drain Current	TC=100°C	13	А
I _{DM}	Pulsed Drain Current	102	А	
I _{DSM}	Continuous Drain Current ^a	TA=25℃	8.6	А
		TA=70 ℃	5.8	А
PD	Power Dissipation ^c	TC=25℃	24	W
		TC=100°C	9.5	W
P _{DSM}	Derver Dissingtion 8	TA=25℃	3	W
	Power Dissipation ^a	TA=70 °C	2	W
E _{AS}	Avalanche Energy L=0.1mH		42	mJ
TJ	Operation junction temperature		-55 to 150	°C
T _{STG}	Storage temperature range		-55 to 150	°C

➤ Absolute Maximum Ratings(T_A=25°C unless otherwise noted)

> Thermal Resistance Ratings($T_A=25^{\circ}C$ unless otherwise noted)

Symbol	Parameter Typ		Maximum	Unit
$R_{ extsf{ heta}JA}$	Junction-to-Ambient Thermal Resistance ^a		45	°C/W
$R_{ extsf{ heta}JC}$	Junction-to-Case Thermal Resistance		5.5	C/ VV

Note:

- a. The value of RθJA is measured with the device mounted on 1 in² FR-4 board with 2oz.copper,in a still air environment with TA=25°C. The value in any given application depends on the user is specific board design. The current rating is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation PD is based on TJ(MAX)=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.

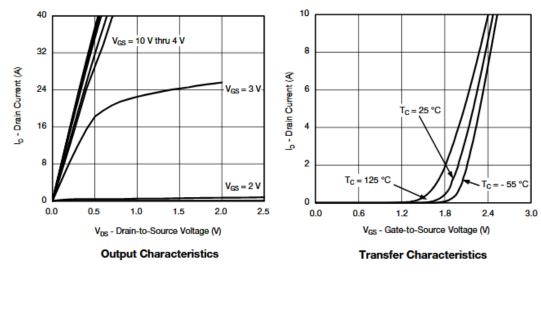


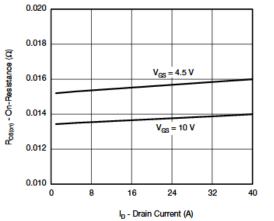
Electronics Characteristics(T_A=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур.	Мах	Unit
V _{(BR)DSS}	Drain-Source Breakdown Voltage	VGS=0V,ID=250uA	30			V
V _{GS} (th)	Gate Threshold Voltage	VDS=VGS,ID=250uA	1		3	V
D	Drain-Source On-	VGS=10V,ID=15A		14	21	
R _{DS(on)}	Resistance	VGS=4.5V,ID=12A		20	36	mR
I _{DSS}	Zero Gate Voltage Drain Current	VDS=24V,VGS=0V			1	uA
I _{GSS}	Gate-Source leak current	VGS=±20V,VDS=0V			±100	nA
G _{FS}	Transconductance	VDS=15V,ID=12A		16		S
V _{SD}	Forward Voltage	VGS=0V,IS=1A		0.8	1.5	V
Ciss	Input Capacitance			550		
Coss	Output Capacitance	VDS=15V, VGS=0V, f=1MHz		180		pF
Crss	Reverse Transfer Capacitance			95		
T _{D(ON)}	Turn-on delay time			16		
Tr	Rise Time	VGS=10V,		32		
T _{D(OFF)}	Turn-off delay time	VDS=15V, RL=2.3R, RG=3R		18		ns
Tf	Fall Time			55		
Qg	Total Gate Charge			13		
Qgs	Gate Source Charge	VDS=15V , VGS=10V , IDS=7A		1.6		nC
Qgd	Gate Drain Charge			2.4		

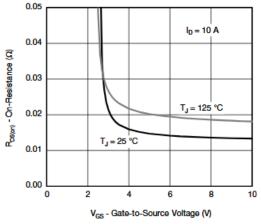


> Typical Characteristics(T_A=25°C unless otherwise noted)

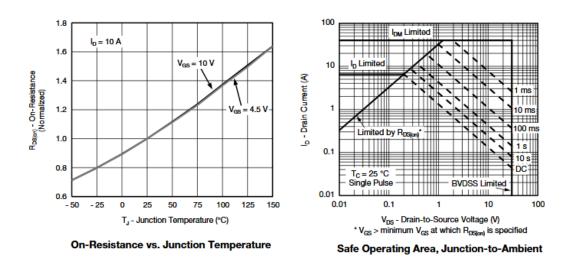




On-Resistance vs. Drain Current and Gate Voltage

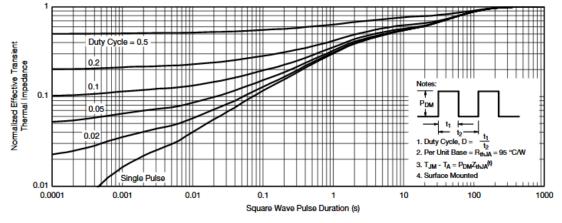


On-Resistance vs. Gate-to-Source Voltage





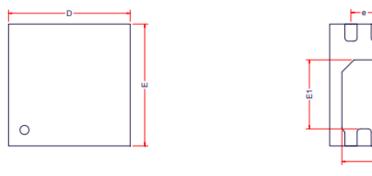
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Normalized Thermal Transient Impedance, Junction-to-Ambient



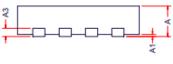
Package Information



BOTTOM VIEW

D1

TOP VIEW



SIDE VIEW

DFN3X3-8L

Sumbol	Dimensions in Millimeters			
Symbol	Min.	Тур.	Max.	
A	0.70	0.75	0.80	
A1	0.00	0.02	0.05	
A2	0.20Ref			
D	2.90	3.00	3.10	
E	2.90	3.00	3.10	
D1	2.35	2.40	2.45	
E1	1.65	1.70	1.75	
b	0.25	0.30	0.35	
е	0.65BSC			
L	0.37	0.42	0.47	



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